## Declaration and Power of Attorney For Patent Application English Language Declaration

As a below named inventor, I hereby declare that:						
My residence, post office address and citizenship are as stated below next to my name,						
first and joint inventor ( and for which a patent ADVERTISEMENT DAT. the specification of whi was filed on United States App and was amended	olication Number or PCT Internation on (if applicable). Febr	of the subject matter whiled ADVERTISEMENT DAT AND SYSTEM FOR THE Se following box is checked attional Application Number Tuary 15, 2001 by Prel	ich is claimed A SUPPLYING METHOD, BAME  :  :  :  :  :  :  :  :  :  :  :  :  :			
I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above.						
I acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR § 1.56.						
I hereby claim foreign priority benefits under 35 U.S.C. §119(a)-(d) or § 365(b) of any foreign application(s) for patent or inventor's certificate, or § 365(a) of any PCT International application which designated at least one country other than the United States, listed below and have also identified below by checking the box, any foreign application for patent or inventor's certificate, or PCT International application having a filing date before that of the application on which priority is claimed:  Prior Foreign Application(s)  Priority Not Claimed 2000-037,279  JAPAN  February 15, 2000						
(Number)	(Country)	(Day/Month/Year Filed)				
(Number)	(Country)	(Day/Month/Year Filed)				
I hereby claim the benefit under 35 U.S.C. § 119(e) of any United States provisional application(s) listed below.						
(Application Number)	(Filing Date)		•			
(Application Number)	(Filing Date)					
I hereby claim the benefit under 35 U.S.C. § 120 of any United States application(s), or 365(c) of any PCT International application designating the United States, listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States or PCT International application in the manner provided by the first paragraph of 35 U.S.C. § 112, I acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR § 1.56 which became available between the filing date of the prior application and the national or PCT international filing date of this application:						

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(Application Number)		(Filing Date)	(Status - pate	(Status - patented, pending, abandoned)	
(Application Number)		(Filing Date)	(Status - pate	(Status - patented, pending, abandoned)	
	ecute this app			int the following at the Patent and T	
Paul F. Prestia Allan Ratner Andrew L. Ney Kenneth N. Nigon Kevin R. Casey Benjamin E. Leace James C. Simmons	Reg. No. 23,031 Reg. No. 19,717 Reg. No. 20,300 Reg. No. 31,549 Reg. No. 32,117 Reg. No. 33,412 Reg. No. 24,842	Lawrence E. Ashery Christopher R. Lewis Robert L. Andersen Joshua L. Cohen Daniel N. Calder Louis W. Beardell, Jr. Jacques L. Etkowicz	Reg. No. 34,515 Reg. No. 36,201 Reg. No. 25,771 Reg. No. 38,040 Reg. No. 27,424 Reg. No. 40,506 Reg. No. 41,738	Jack J. Jankovitz Jonathan H. Spadt Christopher I. Halliday Scott A. Mckeown	Reg. No. 42,690 Reg. No. 45,122 Reg. No. 42,621 Reg. No. 42,866
	a, Suite 301, Or			Valley Forge, PA 19	<del>)</del> 482-0980
statements made were made with by fine or impris such willful false	e on informatio the knowledge onment, or bot statements ma	n and belief are be that willful false th, under Section 1	lieved to be true statements and 001 of Title 18 of idity of the applic	on knowledge are to e; and further that the dithe like so made of the United States cation or any patent	nese statements are punishable s Code and that
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